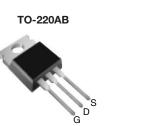
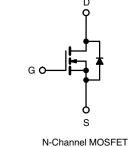


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	400			
R _{DS(on)} (Ω)	V _{GS} = 10 V 1.0			
Q _g (Max.) (nC)	22			
Q _{gs} (nC)	5.8			
Q _{gd} (nC)	9.3			
Configuration	Single			





FEATURES

• Low Gate Charge Q_q results in Simple Drive Requirement



RoHS

COMPLIANT

- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Single Transistor Flyback Xfmr. Reset
- Single Transistor Forward Xfmr. Reset (Both US Line Input Only)

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF730APbF		
Leau (FD)-liee	SiHF730A-E3		
SnPb	IRF730A		
SIFD	SiHF730A		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	400	- V	
Gate-Source Voltage			V _{GS}	± 30		
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	1-	5.5		
		T _C = 100 °C	I _D	3.5	А	
Pulsed Drain Current ^a			I _{DM}	22		
Linear Derating Factor				0.6	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	290	mJ	
Repetitive Avalanche Current ^a			I _{AR}	5.5	A	
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ	
Maximum Power Dissipation	T _C =	25 °C	PD	74	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.6	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		-	300 ^d	7	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25$ °C, L = 19 mH, $R_g = 25 \Omega$, $I_{AS} = 5.5 A$ (see fig. 12).

c. $I_{SD} \le 5.5$ Å, dl/dt ≤ 90 Å/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91045 S11-0508-Rev. B, 21-Mar-11 www.vishay.com

Vishay Siliconix



THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP		MAX.			UNIT	
Maximum Junction-to-Case (Drain)	R _{thJC}	-		1.70				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50		-		°C/W		
Maximum Junction-to-Ambient	R _{thJA}	- 62			-			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static		•						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 2	250 μA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	_	0.5	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2.0	-	4.5	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$	V	I	-	± 100	nA
Zero Gate Voltage Drain Current	le e e	V _{DS} =	= 400 V, V _G s	₆ = 0 V	-	-	25	μA
Zero Gate Voltage Drain Gurrent	IDSS	V _{DS} = 320 \	/, V _{GS} = 0 V	, T _J = 125 °C	-	-	250	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$ $I_D = 3.3 \text{ A}^{b}$		-	-	1.0	Ω	
Forward Transconductance	g fs	V _{DS} = 50 V, I _D = 3.3 A		3.1	-	-	S	
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	600	-	n E	
Output Capacitance	C _{oss}			-	103	-		
Reverse Transfer Capacitance	C _{rss}			-	4.0	-		
Output Capacitance	C		$V_{DS} = 1.0$) V, f = 1.0 MHz	-	890	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = 320 \text{ V}, \text{ f} = 1.0 \text{ MHz}$ $V_{DS} = 0 \text{ V to } 320 \text{ V}^{c}$		-	30	-	-
Effective Output Capacitance	C _{oss} eff.				-	45	-	
Total Gate Charge	Qg				-	-	22	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 3.5 \text{ A}, V_{DS} = 320 \text{ V}$		-	-	5.8	nC
Gate-Drain Charge	Q _{gd}		see fig	g. 6 and 13 ^b	-	-	9.3	1
Turn-On Delay Time	t _{d(on)}				-	10	-	
Rise Time	t _r	$\begin{split} V_{DD} &= 200 \text{ V}, \text{ I}_{D} = 3.5 \text{ A} \\ \text{R}_{g} &= 12 \ \Omega, \text{ R}_{D} = 57 \ \Omega, \\ \text{see fig. } 10^{\text{b}} \end{split}$		_	22	-		
Turn-Off Delay Time	t _{d(off)}			-	20	-	ns	
Fall Time	t _f			-	16	-		
Drain-Source Body Diode Characteristi	cs	•				<u> </u>		
Continuous Source-Drain Diode Current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5.5		
Pulsed Diode Forward Current ^a	I _{SM}			-	-	22	A	
Body Diode Voltage	V _{SD}	T _J = 25 °C	C, I _S = 5.5 A	$V_{GS} = 0 V^{b}$	-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}		- 9 5 4 -	(dt _ 100 ^ /	-	370	550	ns
Body Diode Reverse Recovery Charge	Q _{rr}	- T _J = 25 °C, I _F = 3.5 A, dI/dt = 100 A/µs ^b			-	1.6	2.4	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on			-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}.

www.vishay.com 2 Document Number: 91045 S11-0508-Rev. B, 21-Mar-11



Vishay Siliconix

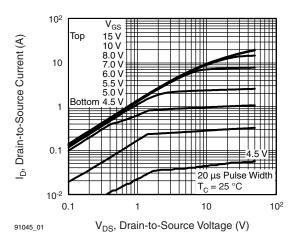


Fig. 1 - Typical Output Characteristics

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

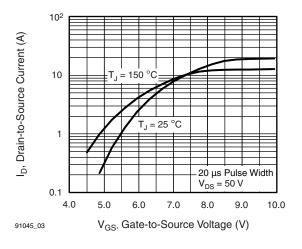


Fig. 3 - Typical Transfer Characteristics

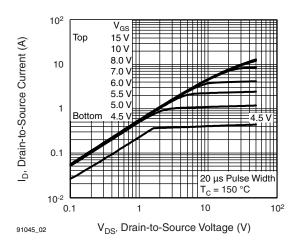


Fig. 2 - Typical Output Characteristics

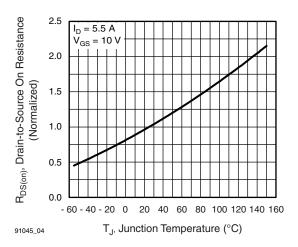


Fig. 4 - Normalized On-Resistance vs. Temperature

www.vishay.com

3

Vishay Siliconix



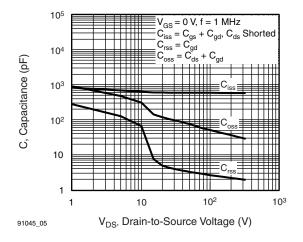


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

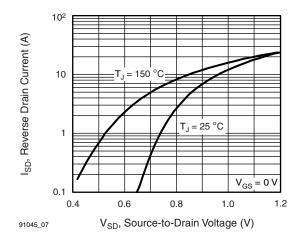


Fig. 7 - Typical Source-Drain Diode Forward Voltage

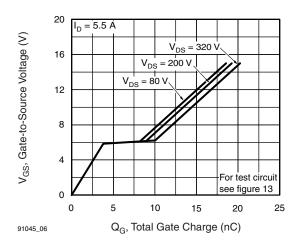


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

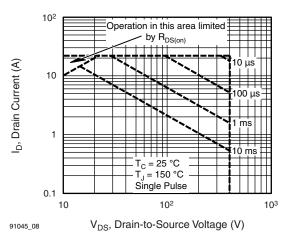


Fig. 8 - Maximum Safe Operating Area

Document Number: 91045 S11-0508-Rev. B, 21-Mar-11



Vishay Siliconix

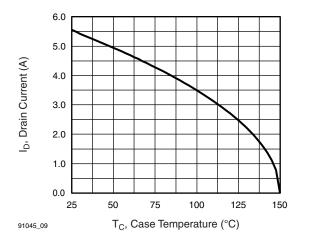


Fig. 9 - Maximum Drain Current vs. Case Temperature

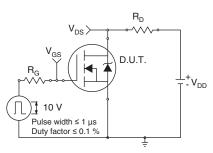


Fig. 10a - Switching Time Test Circuit

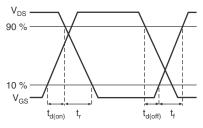


Fig. 10b - Switching Time Waveforms

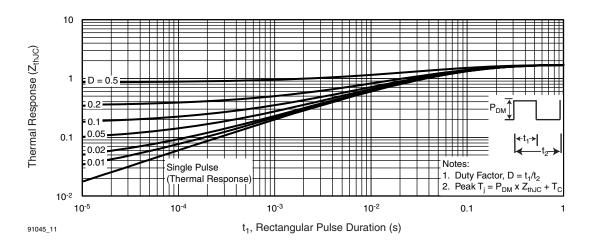


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

Vishay Siliconix



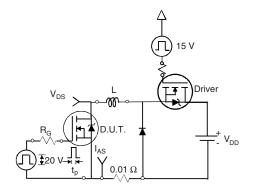


Fig. 12a - Unclamped Inductive Test Circuit

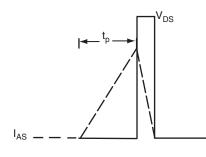


Fig. 12b - Unclamped Inductive Waveforms

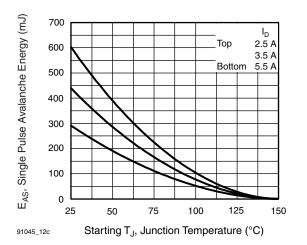


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

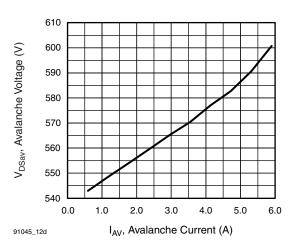


Fig. 12d - Typical Drain Source Voltage vs. Avalanche Current

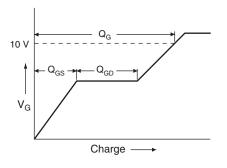


Fig. 13a - Basic Gate Charge Waveform

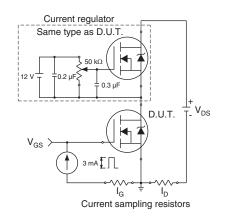


Fig. 13b - Gate Charge Test Circuit

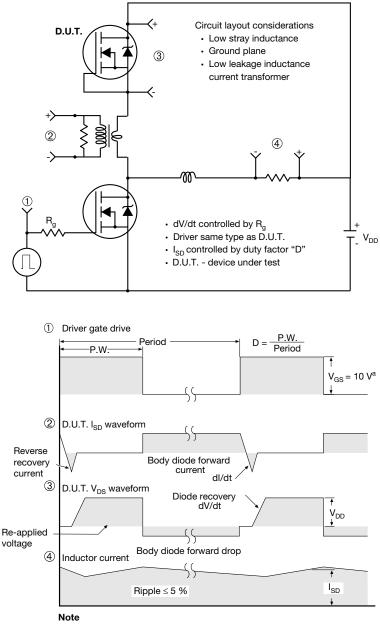
www.vishay.com 6 Document Number: 91045 S11-0508-Rev. B, 21-Mar-11



Vishay Siliconix







a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91045</u>.

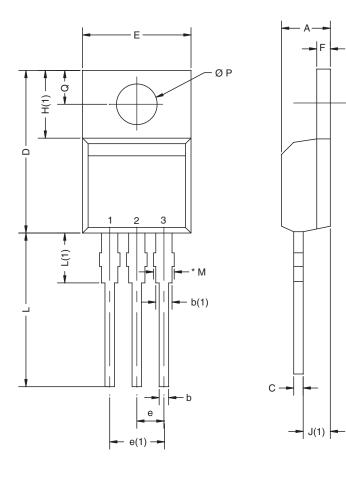
Document Number: 91045 S11-0508-Rev. B, 21-Mar-11 www.vishay.com



Package Information

Vishay Siliconix

TO-220AB



	MILLIMETERS		INC	CHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
	0416-Rev. M,		0.102	0.11	

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.